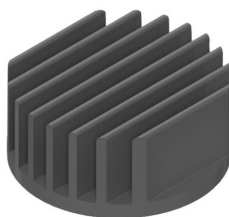


Data sheet Product ICK LED R 32 x 14

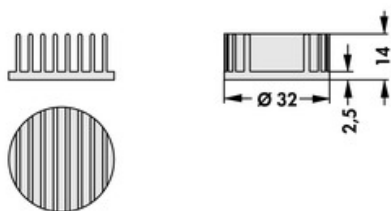


Heatsinks and active heatsinks for processors>Heatsinks for LEDs
Ø 32 x 14 mm, for IC design LED

Features

diameter:	29 mm
way of fixation:	• therm. conductive foil • therm. cond. adhesive
height:	14 mm
plate thickness:	2.5 mm
thermal resistance:	15.23 K/W
dissipation loss:	7.8 W
surface:	black anodised

Technical Drawing



$$R_{th} = 15,23 \text{ K/W}$$